UTC UNISONIC TECHNOLOGIES CO., LTD

1N60Q-TA **Preliminary** Power MOSFET

1.0A, 600V N-CHANNEL POWER MOSFET

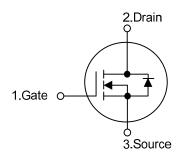
DESCRIPTION

The UTC 1N60Q-TA is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 9.00 @ V_{GS} =10V, I_{D} =0.5A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL

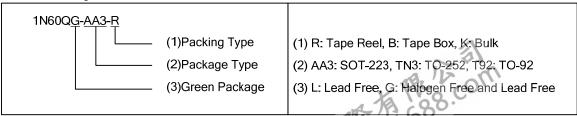


SOT-223 TO-252 1 TO-92

ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
-	1N60Q G-AA3-R	SOT-223	G	D	S	Tape Reel	
1N60QL-TN3-R	1N60QG-TN3-R	TO-252	G	D	S	Tape Reel	
1N60QL-T92-B	1N60QG-T92-B	⁻ 92-B TO-92 G D S		Tape Box			
1N60QL-T92-K	1N60QG-T92-K	TO-92	G	D	S	Bulk	

Note: Pin Assignment: G: Gate D: Drain S: Source



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MARKING

PACKAGE	MARKING
SOT-223	Lot Code ← 1 Data Code
TO-252	UTC 1N60Q□ C: Lead Free C: Halogen Free Data Code 1
TO-92	UTC 1N60Q□ G: Halogen Free Lot Code Data Code

Preliminary



■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Outilities David Outlier	Continuous (T _C =25°C)	I _D	1.0	Α
Continuous Drain Current	Pulsed (Note 2)	I_{DM}	4.0	Α
Avalanche Current (Note 2)		I_{AR}	1	Α
Avalanche Energy	Single Pulsed (Note 2)	E _{AS}	60	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.5	V/ns
Power Dissipation	SOT-223		7.8	W
	TO-252	P_{D}	28	W
	TO-92		1.56	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 120mH, I_{AS} = 1A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 1A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL RESISTANCES CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	SOT-223		150	°C/W	
	TO-252	$ heta_{JA}$	140	°C/W	
	TO-92		110	°C/W	
Junction to Case	SOT-223		16	°C/W	
	TO-252	θ_{JC}	4.46	°C/W	
	TO-92		80	°C/W	



ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified.)

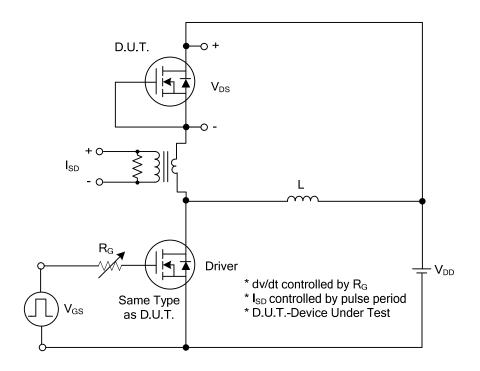
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	600			V	
Drain-Source Leakage Current	I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μA	
Forward	I _{GSS}	V_{GS} =30V, V_{DS} =0V			100	nA	
Gate-Source Leakage Current Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_{D} =0.5A			9.0	Ω	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C _{ISS}			195		pF	
Output Capacitance	Coss	V_{DS} =25V, V_{GS} =0V, f=1MHz		20		pF	
Reverse Transfer Capacitance	C _{RSS}			3		pF	
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)	Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		13		nC	
Gate-Source Charge	Q_GS	I _G =100μA (Note 1, 2)		1.3		nC	
Gate-Drain Charge	Q_GD	IG-100μΑ (Note 1, 2)		1		nC	
Turn-On Delay Time (Note 1)	t _{D(ON)}			28		ns	
Turn-On Rise Time	t _R	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A,		19		ns	
Turn-Off Delay Time	t _{D(OFF)}	$R_G=25\Omega(Note 1, 2)$		53		ns	
Turn-Off Fall Time	t _F			25		ns	
SOURCE-DRAIN DIODE RATINGS AND CHA	ARACTERIST	TICS					
Maximum Continuous Drain-Source Diode	Is				1	Α	
Forward Current					ı	A	
Maximum Pulsed Drain-Source Diode	I _{SM}				4	Α	
Forward Current					+		
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	V _{GS} =0V, I _S =1.0A			1.4	V	
Reverse Recovery Time (Note 1)	t _{rr}	V _{GS} = 0V, I _S = 1.0A,		200		nS	
Reverse Recovery Charge	Q_{rr}	dI _F / dt =100A/µs (Note 1)		0.44		μC	

Notes: 1. Pulse Test: Pulse width \leq 300 μ s, Duty cycle \leq 2%.

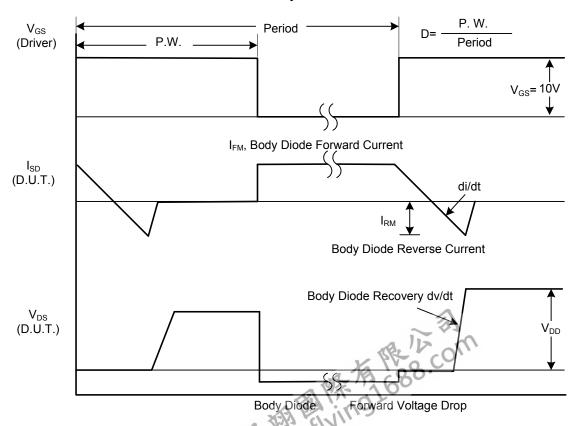


^{2.} Essentially independent of operating temperature.

TEST CIRCUITS AND WAVEFORMS

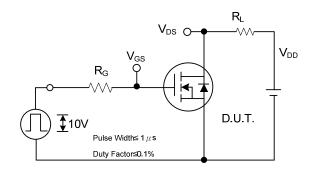


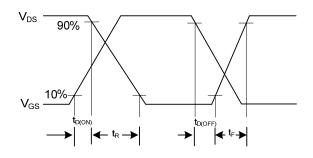
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

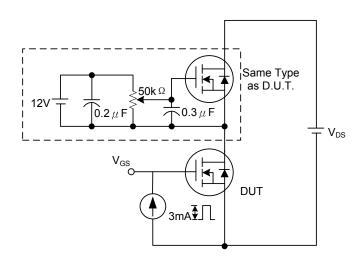
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

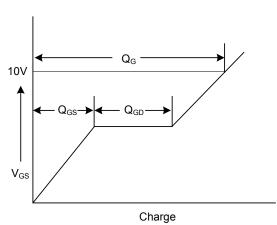




Switching Test Circuit

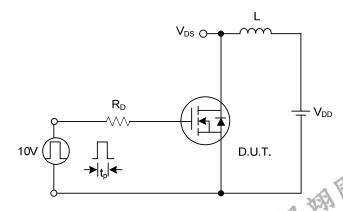
Switching Waveforms

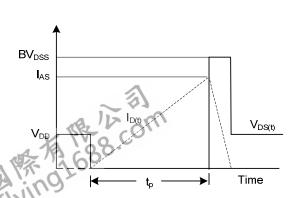




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms



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